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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
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BLL6G1214L-250

LDMOS L-band radar power transistor

Rev. 3 — 28 January 2016 | **Product data sheet**

1. Product profile

1.1 General description

250 W LDMOS power transistor intended for L-band radar applications in the 1.2 GHz to 1.4 GHz range.

Table 1. Test information

Typical RF performance at T_{case} = 25 °C; t_p = 1 ms; δ = 10 %; I_{Dq} = 150 mA; in a class-AB production test circuit.

Test signal	f	V_{DS}	P_L	G_p	η_D	t_r	t_f
	(GHz)	(V)	(W)	(dB)	(%)	(ns)	(ns)
pulsed RF	1.2 to 1.4	36	250	15	45	15	5

1.2 Features and benefits

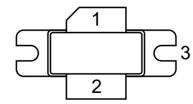
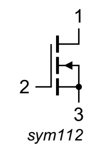
- Easy power control
- Integrated ESD protection
- High flexibility with respect to pulse formats
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (1.2 GHz to 1.4 GHz)
- Internally matched for ease of use
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

- L-band power amplifiers for radar applications in the 1.2 GHz to 1.4 GHz frequency range

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	drain		
2	gate		
3	source [1]		

[1] Connected to flange

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BLL6G1214L-250	-	flanged ceramic package; 2 mounting holes; 2 leads	SOT502A

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	89	V
V_{GS}	gate-source voltage		−0.5	+11	V
T_{stg}	storage temperature		−65	+150	°C
T_j	junction temperature		-	200	°C

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Typ	Unit
$R_{th(j\text{-}case)}$	thermal resistance from junction to case	T_{case} = 85 °C; P_L = 250 W	0.244	K/W
$Z_{th(j\text{-}c)}$	transient thermal impedance from junction to case	T_{case} = 85 °C; P_L = 250 W [1]		
		t_p = 1000 μs; δ = 10 %	0.124	K/W
		t_p = 100 μs; δ = 10 %	0.059	K/W
		t_p = 200 μs; δ = 10 %	0.077	K/W
		t_p = 300 μs; δ = 10 %	0.088	K/W
		t_p = 100 μs; δ = 20 %	0.078	K/W

[1] $Z_{th(j\text{-}c)}$ values are calculated from results obtained with ANSYS simulations and confirmed with IR measurements during development stage. During production: guaranteed by design.

6. Characteristics

Table 6. DC Characteristics

T_j = 25 °C

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	V_{GS} = 0 V; I_D = 3.36 mA	91.5	-	105.5	V
$V_{GS(th)}$	gate-source threshold voltage	V_{DS} = 20 V; I_D = 336 mA	1.4	1.9	2.4	V
I_{DSS}	drain leakage current	V_{GS} = 0 V; V_{DS} = 42 V	-	-	4.2	μA
I_{DSX}	drain cut-off current	V_{GS} = $V_{GS(th)}$ + 3.75 V; V_{DS} = 10 V	50	59	-	A
I_{GSS}	gate leakage current	V_{GS} = 11 V; V_{DS} = 0 V	-	-	420	nA
g_{fs}	forward transconductance	V_{DS} = 10 V; I_D = 336 mA	51.6	-	-	mS
$R_{DS(on)}$	drain-source on-state resistance	V_{GS} = $V_{GS(th)}$ + 3.75 V; I_D = 11.7 A	-	-	127	mΩ

Table 7. AC Characteristics

T_j = 25 °C

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
C_{iss}	input capacitance	V_{GS} = 0 V; V_{DS} = 40 V; f = 1 MHz	-	285	-	pF
C_{oss}	output capacitance	V_{GS} = 0 V; V_{DS} = 40 V; f = 1 MHz	-	90	-	pF
C_{rss}	reverse transfer capacitance	V_{GS} = 0 V; V_{DS} = 40 V; f = 1 MHz	-	3	-	pF

Table 8. RF characteristics

Test signal: pulsed RF; t_p = 1 ms; δ = 10 %; RF performance at V_{DS} = 36 V; I_{Dq} = 150 mA; T_{case} = 25 °C; unless otherwise specified, in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
P_L	output power		250	-	-	W
f_{range}	frequency range		1200	-	1400	MHz
t_p	pulse duration	δ = 10 %	-	-	1	ms
		δ = 20 %	-	-	100	μs
η_D	drain efficiency		42	45	-	%
t_r	rise time	P_L = 250 W [1]	-	-	200	ns
t_f	fall time	P_L = 250 W [1]	-	-	200	ns
G_p	power gain		13	15	-	dB
$P_{droop(pulse)}$	pulse droop power		-	-	0.6	dB
RL_{in}	input return loss		-	-	–7	dB

[1] The rise and fall time of the input circuit will be 5 ns maximum.

7. Test information

7.1 Ruggedness in class-AB operation

The BLL6G1214L-250 is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 36 V; I_{Dq} = 150 mA; P_L = 250 W; t_p = 1 ms; δ = 10 %.

7.2 Impedance information

Table 9. Typical impedance

Typical values unless otherwise specified.

f	Z_S	Z_L
(GHz)	(Ω)	(Ω)
1.2	1.077 – j2.78	1.288 – j1.014
1.3	1.352 – j2.949	1.139 – j1.086
1.4	1.881 – j2.640	1.038 – j1.132

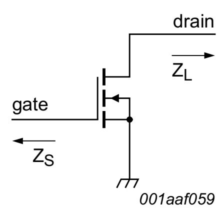
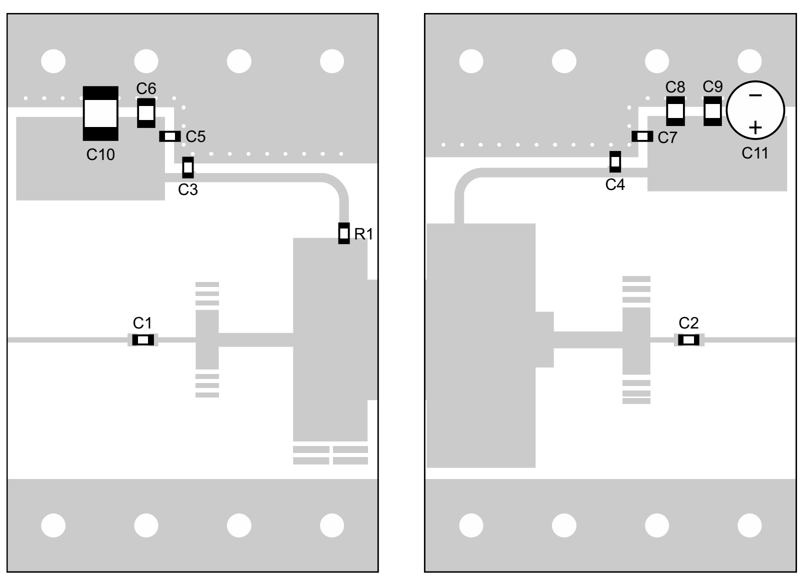


Fig 1. Definition of transistor impedance

7.3 Circuit information



Printed-Circuit Board (PCB): Duroid 6010; ε_r = 10.15; thickness = 0.64 mm; thickness copper plating = 35 μm.

See Table 10 for a list of components.

Fig 2. Component layout for application circuit

Table 10. List of components
For test circuit see Figure 2.

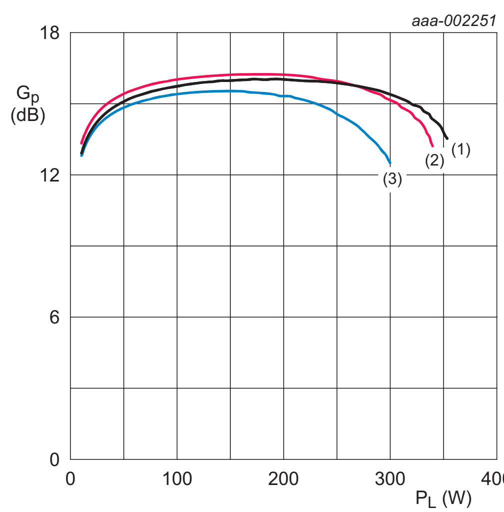
Component	Description	Value	Remarks
C1, C2, C3, C4, C7	multilayer ceramic chip capacitor	56 pF [1]	
C5, C8	multilayer ceramic chip capacitor	200 pF [2]	
C6, C9	multilayer ceramic chip capacitor	1 nF [3]	
C10	multilayer ceramic chip capacitor	10 μF, 20 V	
C11	electrolytic capacitor	22 μF, 63 V	
R1	resistor	10 Ω	SMD 0603

[1] American Technical Ceramics type 100A or capacitor of same quality.

[2] American Technical Ceramics type 100B or capacitor of same quality.

[3] American Technical Ceramics type 700A or capacitor of same quality.

7.4 Graphical data



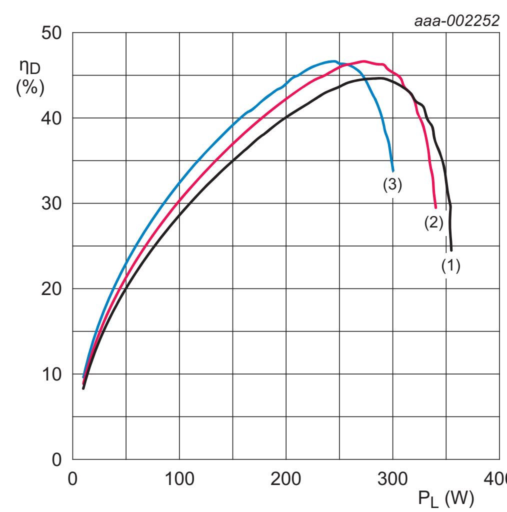
t_p = 100 μs; δ = 10 %; T_h = 25 °C.

(1) f = 1200 MHz

(2) f = 1300 MHz

(3) f = 1400 MHz

Fig 3. Power gain as a function of output power; typical values



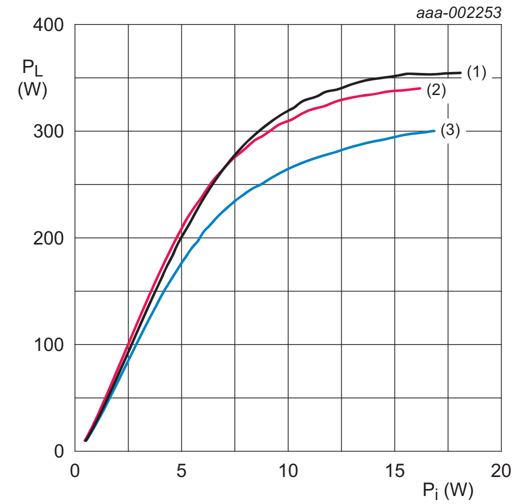
t_p = 100 μs; δ = 10 %; T_h = 25 °C.

(1) f = 1200 MHz

(2) f = 1300 MHz

(3) f = 1400 MHz

Fig 4. Drain efficiency as a function of output power; typical values



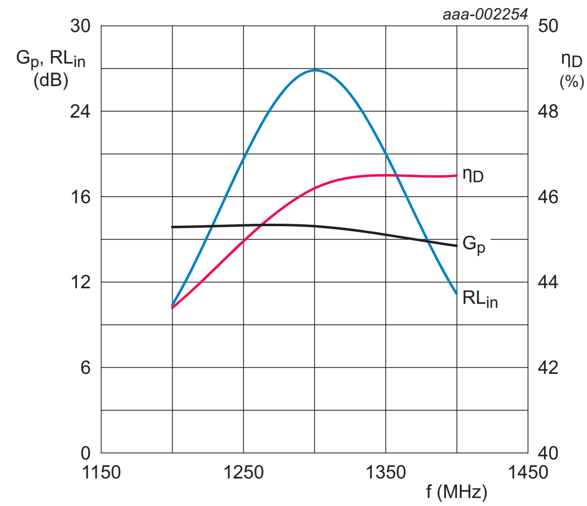
t_p = 100 μs; δ = 10 %; T_h = 25 °C.

(1) f = 1200 MHz

(2) f = 1300 MHz

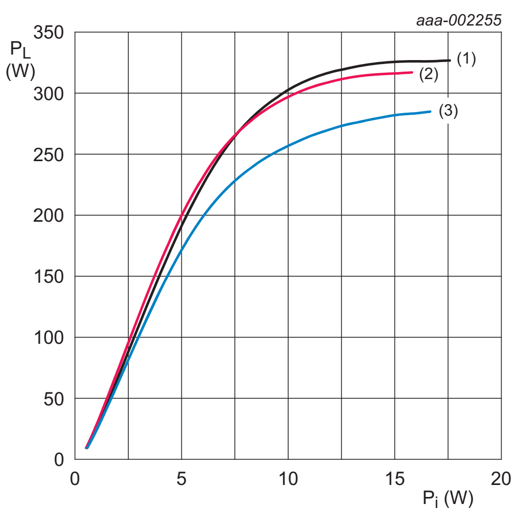
(3) f = 1400 MHz

Fig 5. Output power as a function of input power; typical values



P_L = 250 W; t_p = 100 μs; δ = 10 %; T_h = 25 °C.

Fig 6. Power gain, input return loss and drain efficiency as function of frequency; typical values



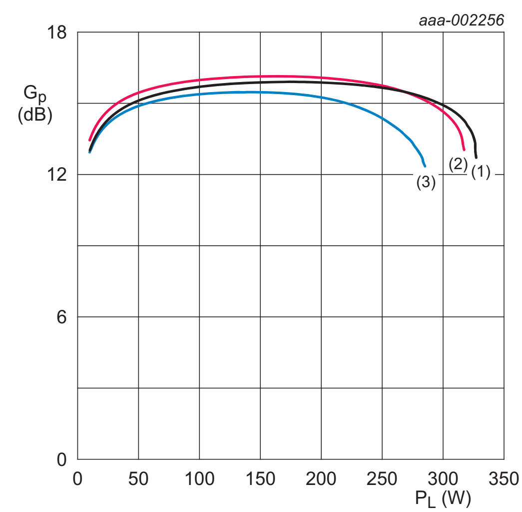
t_p = 1 ms; δ = 10 %; T_h = 25 °C.

(1) f = 1200 MHz

(2) f = 1300 MHz

(3) f = 1400 MHz

Fig 7. Output power as a function of input power; typical values



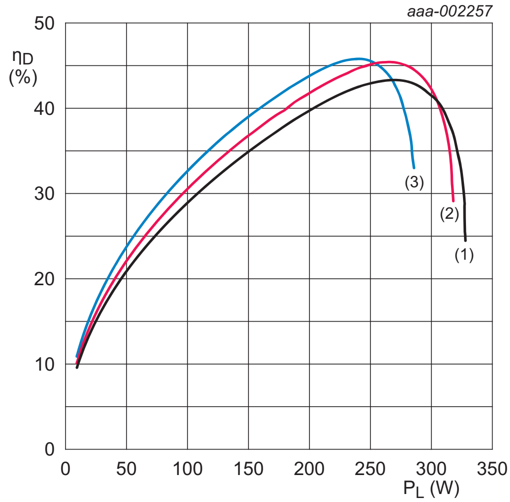
t_p = 1 ms; δ = 10 %; T_h = 25 °C.

(1) f = 1200 MHz

(2) f = 1300 MHz

(3) f = 1400 MHz

Fig 8. Power gain as a function of output power; typical values



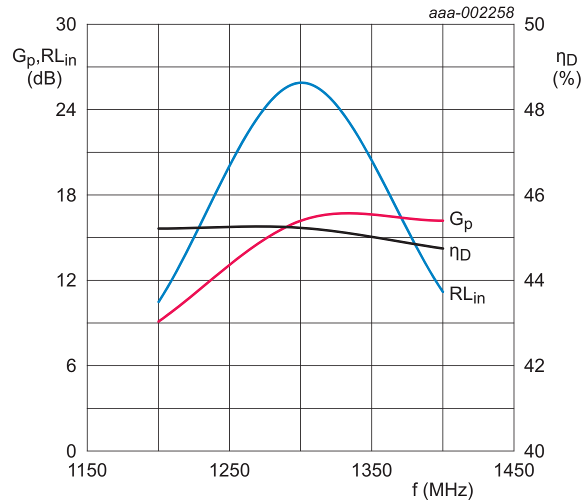
t_p = 1 ms; δ = 10 %; T_h = 25 °C.

(1) f = 1200 MHz

(2) f = 1300 MHz

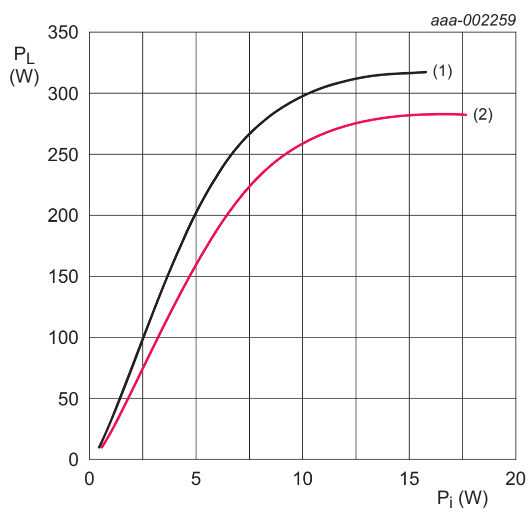
(3) f = 1400 MHz

Fig 9. Drain efficiency as a function of output power; typical values



P_L = 250 W; t_p = 1 ms; δ = 10 %; T_h = 25 °C.

Fig 10. Power gain, input return loss and drain efficiency as function of frequency; typical values

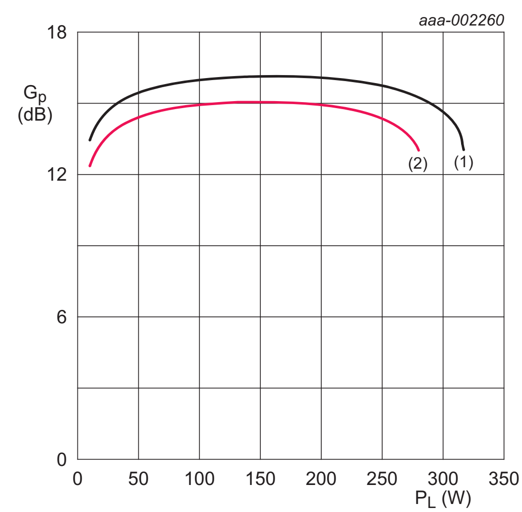


f = 1300 MHz; t_p = 1 ms; δ = 10 %.

(1) T_h = 25 °C

(2) T_h = 85 °C

Fig 11. Output power as a function of input power; typical values

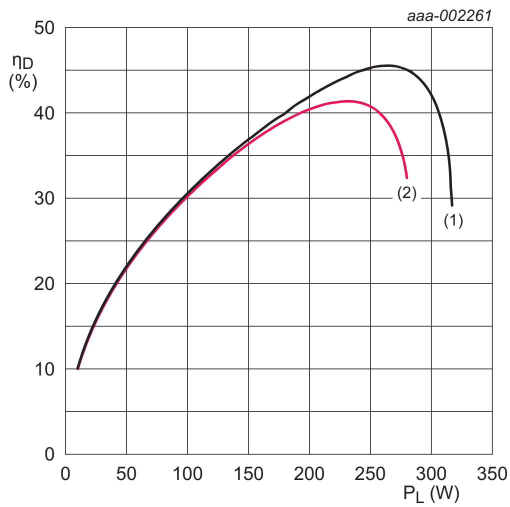


f = 1300 MHz; t_p = 1 ms; δ = 10 %.

(1) T_h = 25 °C

(2) T_h = 85 °C

Fig 12. Power gain as a function of output power; typical values

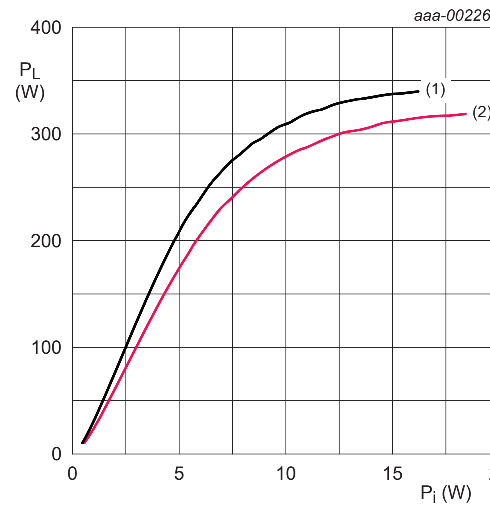


f = 1300 MHz; t_p = 1 ms; δ = 10 %.

(1) T_h = 25 °C

(2) T_h = 85 °C

Fig 13. Drain efficiency as a function of output power; typical values

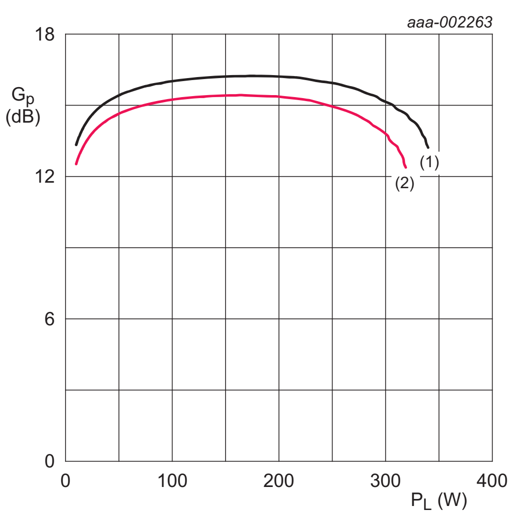


f = 1300 MHz; t_p = 100 μs; δ = 10 %.

(1) T_h = 25 °C

(2) T_h = 85 °C

Fig 14. Output power as a function of input power; typical values

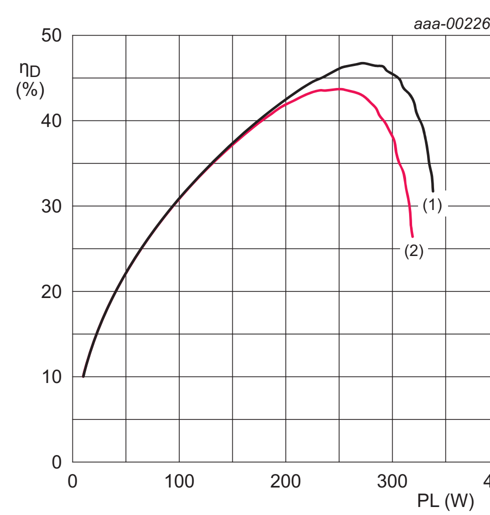


f = 1300 MHz; t_p = 1 ms; δ = 10 %.

(1) T_h = 25 °C

(2) T_h = 85 °C

Fig 15. Power gain as a function of output power; typical values



f = 1300 MHz; t_p = 100 μs; δ = 10 %.

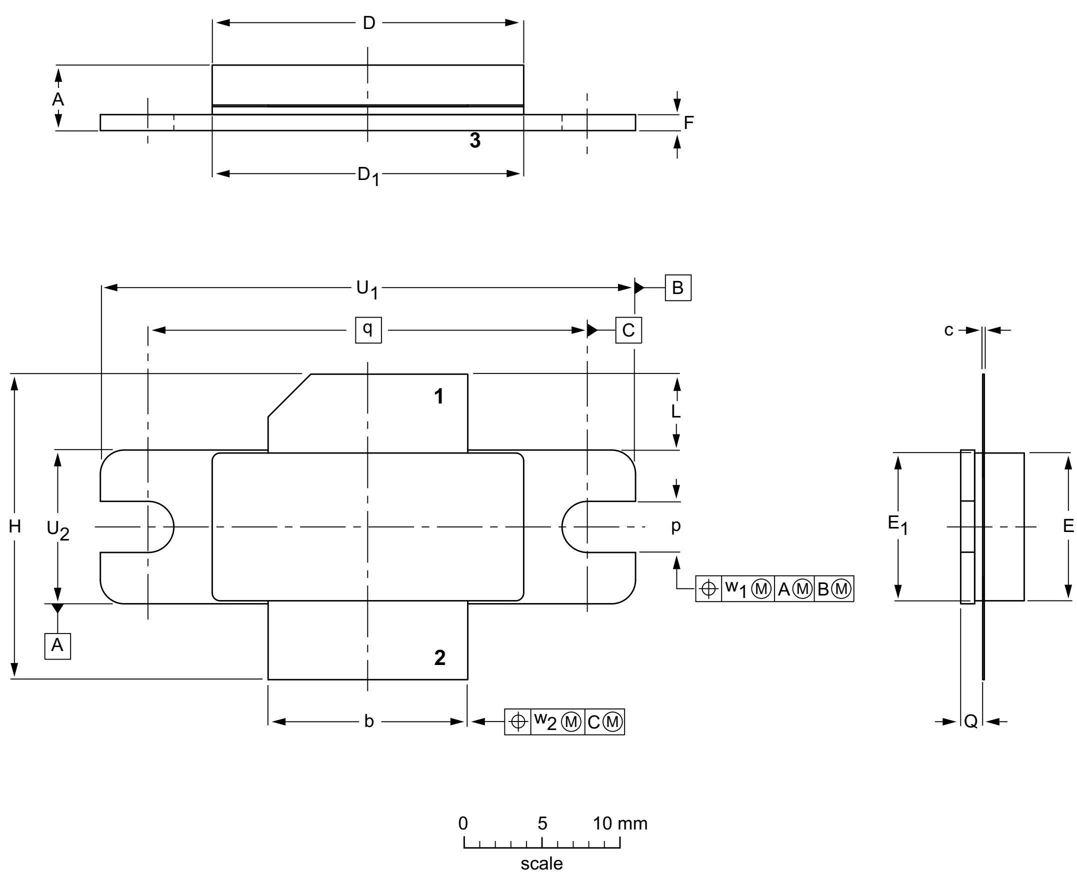
(1) T_h = 25 °C

(2) T_h = 85 °C

Fig 16. Drain efficiency as a function of output power; typical values

8. Package outline

Flanged ceramic package; 2 mounting holes; 2 leads **SOT502A**



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	c	D	D_1	E	E_1	F	H	L	p	Q	q	U_1	U_2	w_1	w_2
mm	4.72 3.43	12.83 12.57	0.15 0.08	20.02 19.61	19.96 19.66	9.50 9.30	9.53 9.25	1.14 0.89	19.94 18.92	5.33 4.32	3.38 3.12	1.70 1.45	27.94	34.16 33.91	9.91 9.65	0.25	0.51
inches	0.186 0.135	0.505 0.495	0.006 0.003	0.788 0.772	0.786 0.774	0.374 0.366	0.375 0.364	0.045 0.035	0.785 0.745	0.210 0.170	0.133 0.123	0.067 0.057	1.100	1.345 1.335	0.390 0.380	0.01	0.02

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT502A						~~03-01-10~~ 12-05-02

Fig 17. Package outline SOT502A

9. Handling information

CAUTION

This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

10. Abbreviations

Table 11. Abbreviations

Acronym	Description
ESD	ElectroStatic Discharge
IR	InfraRed
L-band	Long wave band
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
SMD	Surface Mounted Device
VSWR	Voltage Standing-Wave Ratio

11. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLL6G1214L-250 v.3	20160128	Product data sheet	-	BLL6G1214L-250_ 1214LS-250 v.2
Modifications	• The document now describes only the eared version of this product: BLL6G1214L-250			
BLL6G1214L-250_1214LS-250 v.2	20130624	Product data sheet	-	BLL6G1214L-250 v.1
BLL6G1214L-250 v.1	20120216	Preliminary data sheet	-	-

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.ampleon.com.

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13. Contact information

For more information, please visit: **http://www.ampleon.com**

For sales office addresses, please visit: **http://www.ampleon.com/sales**

14. Contents

Date of release: 28 January 2016
Document identifier: BLL6G1214L-250